

Features

- Operating voltage: 4.5V~5.5V
- ADM algorithm
- Low noise
 - Echo mode: -85dB
 - Surround mode: -90dB
- Low distortion rate
 - Echo mode: 1%
 - Surround mode: 0.2%
- Long delay time
 - Echo mode: 20.5ms~163.8ms, 8 stages
 - Surround mode: 5.1ms~41ms, 8 stages
- Manual/ μ P control interface
- Built-in 20Kb SRAM
- Automatic mute function
- Automatic reset function
- Package type: 28-pin DIP

Applications

- Television
- Karaoke systems
- Video disc player
- Sound equipments

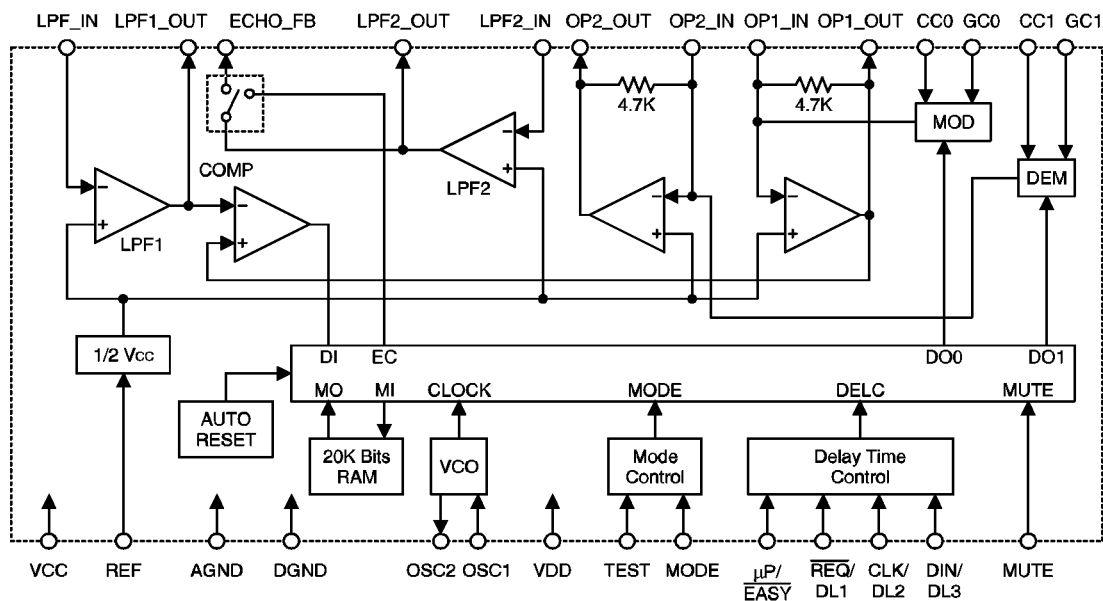
General Description

The HT8960 is an echo/surround effect processor. It is designed for various audio systems including karaoke, television, sound equipments, etc. The chip consists of a built-in pre-amplifier, on-chip oscillator, 20Kb SRAM, A/D and D/A converters as well as delay time control logic.

The HT8960 provides manual and μ P interface to control echo/surround mode and delay time.

It has built-in 20Kb SRAM to generate the effect of delay time and can control the value of delay time through the internal control logic unit. In surround mode the delay time is from 5.1ms to 41ms. On the other hand, the delay time range is from 20.5ms to 163ms in echo mode.

Block Diagram

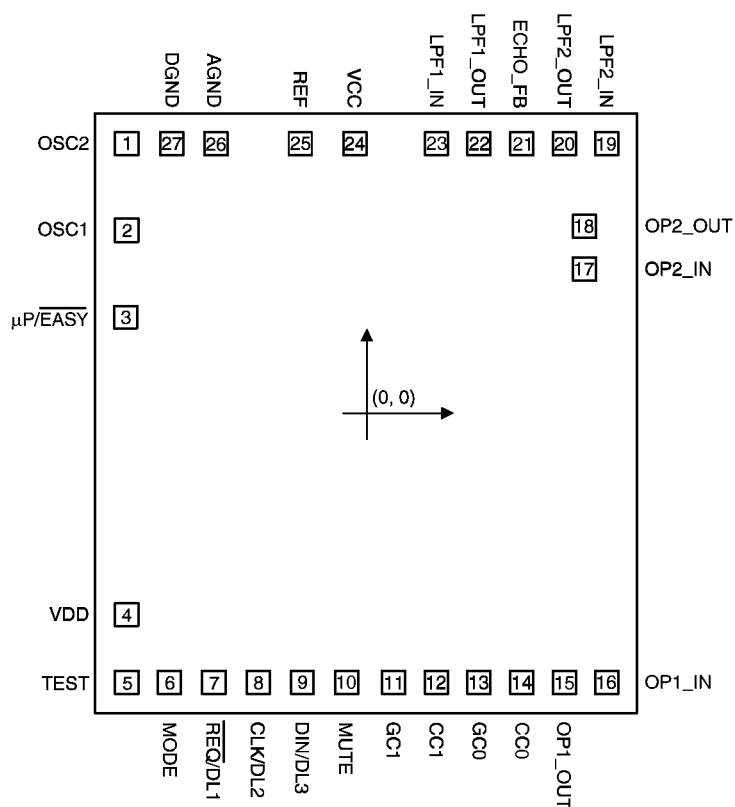


Pin Assignment

VCC	1	28	LPF1_IN
REF	2	27	LPF1_OUT
AGND	3	26	ECHO_FB
DGND	4	25	NC
OSC2	5	24	LPF2_OUT
OSC1	6	23	LPF2_IN
μP/EASY	7	22	OP2_OUT
VDD	8	21	OP2_IN
TEST	9	20	OP1_IN
MODE	10	19	OP1_OUT
REQ/DL1	11	18	CC0
CLK/DL2	12	17	GC0
DIN/DL3	13	16	CC1
MUTE	14	15	GC1

HT8960
- 28 DIP

Pad Assignment



Chip size: $2025 \times 2340 (\mu m)^2$

* The IC substrate should be connected to VSS in the PCB layout artwork.

Pad Coordinates

Unit: μm

Pad No.	X	Y	Pad No.	X	Y
1	-835.80	939.30	15	688.00	-939.25
2	-835.80	637.60	16	836.40	-939.25
3	-840.50	334.15	17	758.85	503.40
4	-835.80	-702.50	18	758.85	651.80
5	-835.80	-939.25	19	836.40	939.20
6	-687.40	-939.25	20	688.00	939.20
7	-533.00	-939.25	21	539.60	939.20
8	-378.60	-939.25	22	391.20	939.20
9	-224.20	-939.25	23	242.80	939.20
10	-70.00	-939.25	24	-41.40	939.25
11	90.40	-939.25	25	-231.40	939.20
12	242.80	-939.25	26	-524.75	939.35
13	391.20	-939.25	27	-679.75	939.35
14	539.60	-939.25			

Pad Description

Pad No.	Pad Name	I/O	Internal Connection	Description
1	OSC2	O	—	System oscillator output
2	OSC1	I	—	System oscillator input
3	$\mu\text{P}/\overline{\text{EASY}}$	I	Pull-low	μP /manual control input 1: μP control mode 0: manual control mode
4	VDD	I	—	Digital and positive power supply
5	TEST	I	Pull-low	Test mode input 1: test mode 0: normal mode
6	MODE	I	Pull-low	Echo/surround mode input 1: echo mode 0: surround mode
7	$\overline{\text{REQ}}/\text{DL1}$	I	Pull-low	μP : data request input Manual: delay time 1 input
8	CLK/DL2	I	Pull-low	μP : serial clock input Manual: delay time 2 input
9	DIN/DL3	I	Pull-low	μP : serial data input Manual: delay time 3 input
10	MUTE	I	Pull-low	Mute control input 1: mute 0: normal mode
11	GC1	—	—	Gain control 1
12	CC1	—	—	Current control 1
13	GC0	—	—	Gain control 0
14	CC0	—	—	Current control 0
15	OP1_OUT	O	—	OP1 output
16	OP1_IN	I	—	OP1 input
17	OP2_IN	I	—	OP2 input
18	OP2_OUT	I	—	OP2 output
19	LPF2_IN	I	—	Low pass filter 2 input
20	LPF2_OUT	O	—	Low pass filter 2 output
21	ECHO_FB	O	—	Echo feedback output
22	LPF1_OUT	O	—	Low pass filter 1 output

Pad No.	Pad Name	I/O	Internal Connection	Description
23	LPF1_IN	I	—	Low pass filter 1 input
24	VCC	I	—	Analog and positive power supply
25	REF	I	—	Analog reference voltage
26	AGND	I	—	Analog ground
27	DGND	I	—	Digital ground

Absolute Maximum Ratings*

Supply Voltage -0.3V to 6V Storage Temperature..... -50°C to 125 °C
Input Voltage..... $V_{SS}-0.3V$ to $V_{DD}+0.3V$ Operating Temperature..... -20°C to 70 °C

*Note: These are stress ratings only. Stresses exceeding the range specified under “Absolute Maximum Ratings” may cause substantial damage to the device. Functional operation of this device at other conditions beyond those listed in the specification is not implied and prolonged exposure to extreme conditions may affect device reliability.

Electrical Characteristics

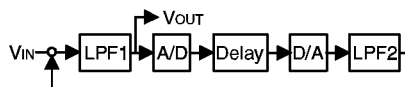
$T_a=25^{\circ}C$

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit	
		V _{DD}	Conditions					
V _{CC}	Operating Voltage	—	—	4.5	5.0	5.5	V	
I _{CC}	Operating Current	5V	—	—	25	44	mA	
G _V	Voltage Gain	5V	R _L =47kΩ	—	−0.5	2.5	dB	
V _{OMAX}	Maximum Output Voltage	5V	THD=10%	0.8	1.4	—	V _{rms}	
THD	Total Harmonic Distortion	5V	30kHz L.P.F.	Echo	—	1.5	2.8	%
				Surround	—	0.3	1	%
N _O	Output Noise Voltage	5V	DIN Audio	Echo	—	−85	−60	dBV
				Surround	—	−90	−70	dBV
PSRR	Power Supply Rejection Ratio	5V	ΔV _{CC} =−20dBV (0.1V _{rms}) f=100Hz		—	−40	−30	dB
T _{MUTE}	Mute Time	5V	Echo		500	515	520	ms
			Surround		125	127	130	ms

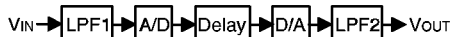
Functional Description

The HT8960 is an echo/surround effect generator with built-in 20Kb SRAM. It ensures low distortion as well as low noise for processing audio signal delay. The chip provides two playing modes (echo and surround) and the playing function block diagrams are shown as follows.

- Echo mode (the mode pin is connected to VDD)



- Surround mode (the mode pin is connected to DGND)

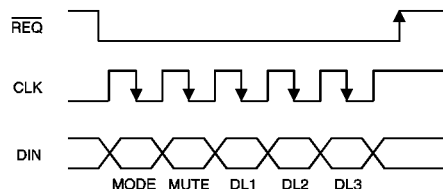


Operating mode

The HT 8960 provides a manual and μP control interface controlled by the $\mu P/\overline{EASY}$ pin. The chip can operate at μP mode and communicate with another μP controller through the $\overline{REQ}/DL1$, $CLK/DL2$ and $DIN/DL3$. The serial data of mode selection, mute function and delay time on the $DIN/DL3$ pin are recognized at the falling edge of the $CLK/DL2$ signal. The relation is shown in the timing diagram. When the $\mu P/\overline{EASY}$ pin connects to DGND, the HT8960 is manipulated at manual mode. The delay time setting is done manually by changing the status of $\overline{REQ}/DL1$, $CLK/DL2$ and $DIN/DL3$. The status of the three pins corresponds to different

delay time. The relation is also displayed in the following table.

- μP mode (the $\mu P/\overline{EASY}$ is connected to VDD)



- Manual mode (the $\mu P/\overline{EASY}$ is connected to DGND)

Pin Name			Surround Mode		Echo Mode	
DL1	DL2	DL3	F _s	T _d	F _s	T _d
L	L	L	500	5.1	250	20.5
H	H	L		10.2		14
H	L	L		15.4		61.4
L	H	L		20.5		81.9
H	L	H	500	25.6	125	102.4
L	L	H		30.7		122.9
L	H	H		35.8		143.4
H	H	H		41		163.8

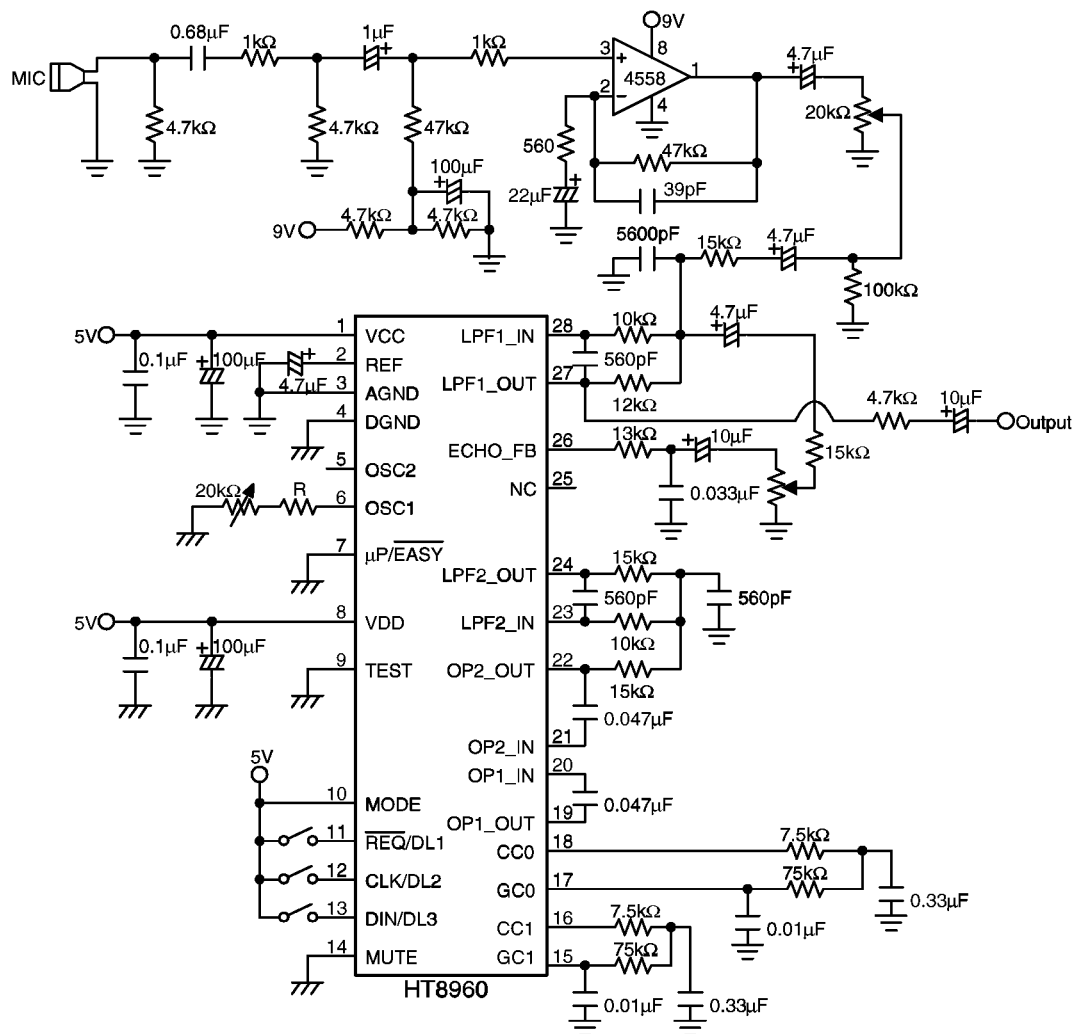
Notes: F_s: Sampling frequency (kHz)

T_d: Delay time (ms)

System frequency f_{OSC}=4MHz

Application Circuits

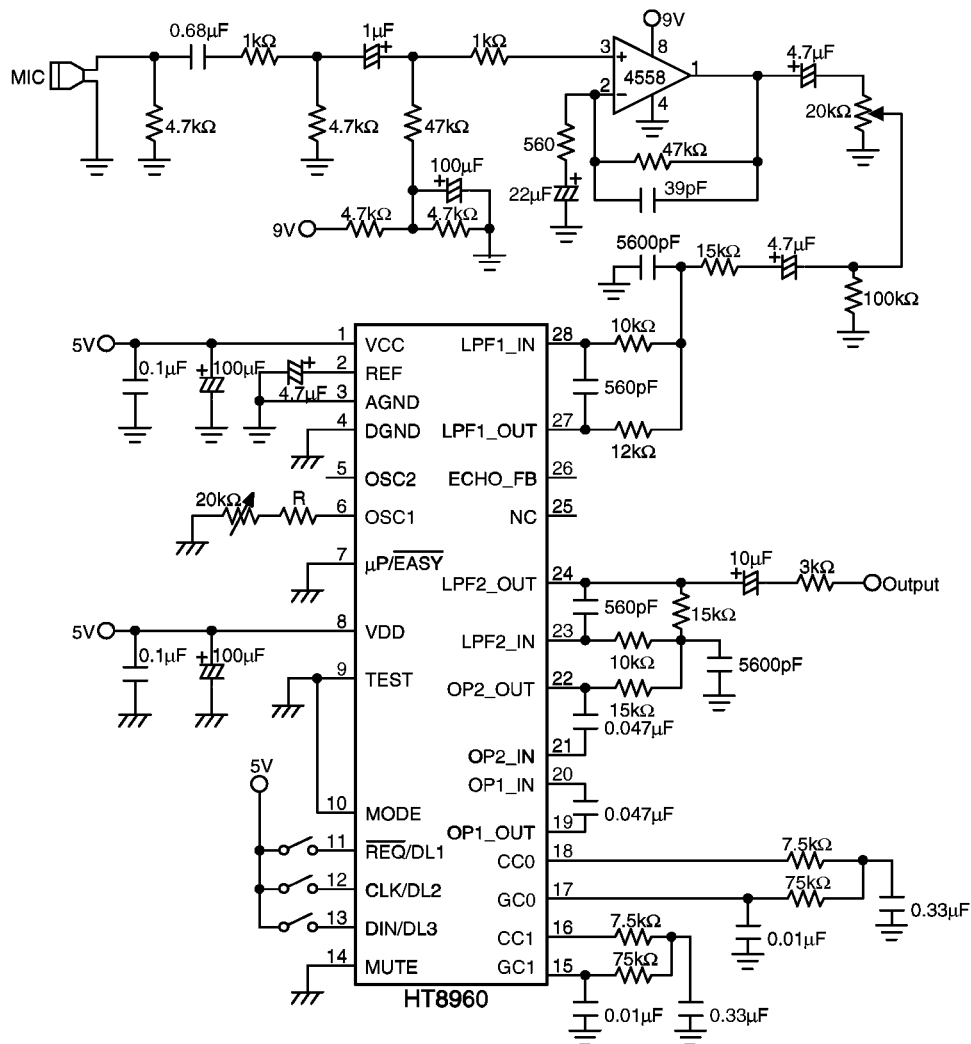
Echo mode



Notes: The external resistor of OSC1 pin is about 15kΩ to 25kΩ

⏏ : Analog ground, ⏏ : Digital ground

Surround mode



Notes: The external resistor of OSC1 pin is about 15kΩ to 25kΩ
 $\equiv$: Analog ground, --- : Digital ground